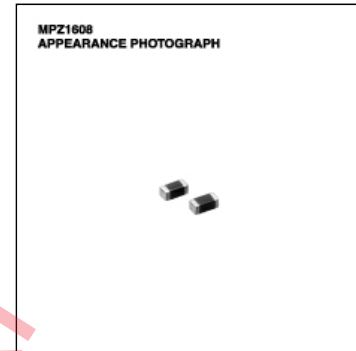




[PAGE BACK](#) [CLOSE](#)

Product Name **Chip Beads**
Series **MPZ Series**
Type **1608 Type**
Model **t=0.8mm**
Part Number **MPZ1608S221ATA00**

Product Lifecycle Stage PROD



Specification

Mounting Method Flag	Yes		
Processing	MULTI-LAYER		
Shape	Chip		
Number of Circuits	Nom	1	
Material Code	S		
Size Code	1608		
Body Length(L)	Nom	1.6 m	m
Body Breadth(W)	Nom	0.8 m	m
Body Height(T)	Nom	0.8 m	m
Impedance	Min	165	Ohm
Impedance	Nom	220	Ohm
Impedance Tolerance	Min	-25	%
	Max	25	%
Frequency of Impedance	Nom	100 M	Hz
Rated Current	Max	2	A
DC Resistance	Max	0.05	Ohm
Soldering Method	Reflow,Iron Soldering		
Category Temperature Range	Min	-55	Cel
	Max	125	Cel
Storage Temperature Range	Min	-55	Cel
	Max	125	Cel
Weight	Nom	0.004	g

Summary/Applications/Feature

Summary	The MPZ series provide effective EMC suppression in signal lines through simple in-series implementation. It is applicable for lead free soldering.		
Applications	PC,DVD,CDMA,LCD,Video game		
Feature	The MPZ series provide effective EMC suppression in signal lines through simple in-series implementation. It is applicable for lead free soldering.		
Packaging	Punched (Paper)Taping [180mm Reel]		
Packing	Minimum Package Qty	Nom	4000 Pcs
	Minimum Order Qty	Nom	4000 Pcs

[Details](#)

■ [Caution]

Specifications which provide more details for the proper and safe use of the described product are available upon request.

■ [Notice of Revision and Improve]

All specifications are subject to change without notice.

[PAGE TOP](#)

Copyright(c) 1996-2008 All rights reserved.